

RoHS

HALOGEN

FREE



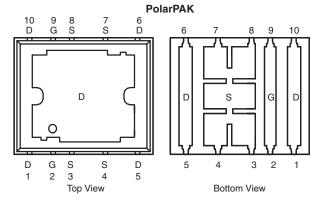
Vishay Siliconix

N-Channel 30-V (D-S) MOSFET

PRODUC	ODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}$ (Ω)	I _D (A) ^e	Q _g (Typ.)		
30	0.007 at V _{GS} = 10 V	44.5	13.1 nC		
30	0.010 at $V_{GS} = 4.5 \text{ V}$	37.3	13.1110		

Package Drawing

www.vishay.com/doc?72945



Top surface is connected to pins 1, 5, 6, and 10 $\,$

Ordering Information: SiE844DF-T1-E3 (Lead (Pb)-free)

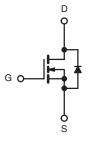
SiE844DF-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Gen II Power MOSFET
- Ultra Low Thermal Resistance Using Top-Exposed PolarPAK[®] Package for Double-Sided Cooling
- Leadframe-Based New Encapsulated Package
 - Die Not Exposed
 - Same Layout Regardless of Die Size
- Low Q_{qd}/Q_{qs} Ratio Helps Prevent Shoot-Through
- 100 % R_g and UIS Tested
- · Compliant to RoHS directive 2002/95/EC

APPLICATIONS

- VRM, POL
- DC/DC Conversion
- Server
- · High-Side Switch



N-Channel MOSFET For Related Documents

www.vishay.com/ppg?69988

ABSOLUTE MAXIMUM RATIN	IGS $T_A = 25 ^{\circ}C$,	unless other	rwise noted	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	± 20	V
	T _C = 25 °C		44.5	
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C	I_	35.6	
Continuous Brain Guirent (1) = 150 G)	T _A = 25 °C	I _D	20.3 ^{a, b}	
	T _A = 70 °C		16.3 ^{a, b}	Α
Pulsed Drain Current		I _{DM}	60	
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	20.8	
Continuous Source-Diam Diode Current	T _A = 25 °C	'S	4.3 ^{a, b}	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	25	
Avalanche Energy	L = 0.111111	E _{AS}	31	mJ
	T _C = 25 °C		25	
Mariana Paras Dissination	T _C = 70 °C	P _D	16	w
Maximum Power Dissipation	T _A = 25 °C	' D	5.2 ^{a, b}	VV
	T _A = 70 °C		3.3 ^{a, b}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C
Soldering Recommendations (Peak Temperature) ^{C, d}			260	

Notes

- a. Surface Mounted on 1" x 1" FR4 board.
- b. t = 10 s
- c. See Solder Profile (www.vishay.com/ppg?73257). The PolarPAK is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- e. Based on $T_C = 25$ °C.

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THERMAL RESISTANCE RATING	iS				
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R _{thJA}	20	24	
Maximum Junction-to-Case (Drain Top)	Steady State	R _{thJC} (Drain)	4 5		°C/W
Maximum Junction-to-Case (Source) ^{a, c}	Olcady Olale	R _{thJC} (Source)	5.5	7	

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. Maximum under Steady State conditions is 68 $^{\circ}\text{C/W}.$
- c. Measured at source pin (on the side of the package).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		30		m\//°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 6		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1		3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zara Cata Valtaga Drain Current	1 .	V _{DS} = 30 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α
	В	V _{GS} = 10 V, I _D = 12.1 A		0.0058	0.007	0
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 9.7 \text{ A}$		0.0081	0.010	Ω
Forward Transconductance ^a	g _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 12.1 \text{ A}$		65		S
Dynamic ^b						•
Input Capacitance	C _{iss}			2150		
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		320		pF
Reverse Transfer Capacitance	C _{rss}			120		1
Total Cata Charma		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		29	44	
Total Gate Charge	Qg			13.1	20	0
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		6		nC
Gate-Drain Charge	Q_{gd}			3.1		1
Gate Resistance	R_{g}	f = 1 MHz		1.2	1.8	Ω
Turn-On Delay Time	t _{d(on)}			25	40	
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω		10	15	1
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_q = 1 \Omega$		25	40	1
Fall Time	t _f	ű		10	15	1
Turn-On Delay Time	t _{d(on)}			10	15	ns
Rise Time	ì,	V_{DD} = 15 V, R_L = 1.5 Ω		10	15	115
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 1 \Omega$		25	40	
Fall Time	Ì,	Č		10	15	1
Drain-Source Body Diode Characteristic	s					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			20.8	
Pulse Diode Forward Current ^a	I _{SM}				60	Α
Body Diode Voltage	V_{SD}	I _S = 10 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			30	45	ns
Body Diode Reverse Recovery Charge Q _{rr}		1 10 A dl/dt 100 A/vo T 05 00		24	36	nC
Reverse Recovery Fall Time t_a $I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		16				
Reverse Recovery Rise Time	t _b			14		ns

Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

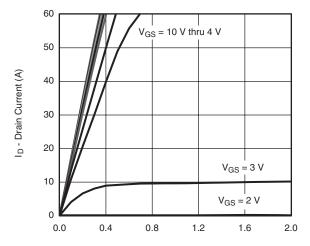
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



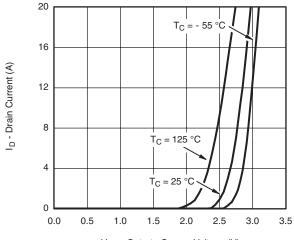


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

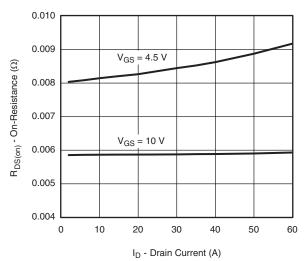


V_{DS} - Drain-to-Source Voltage (V)

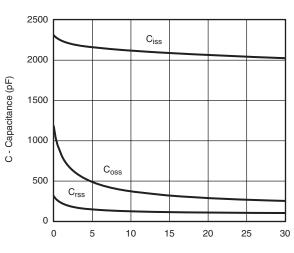


V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**

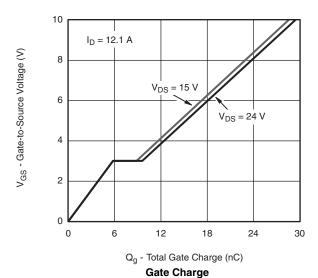


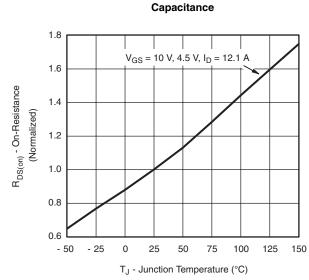


On-Resistance vs. Drain Current



V_{DS} - Drain-to-Source Voltage (V)



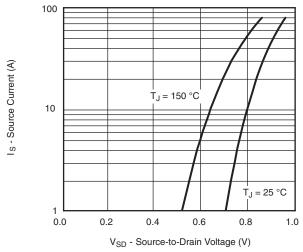


On-Resistance vs. Junction Temperature

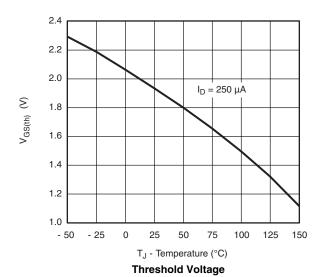
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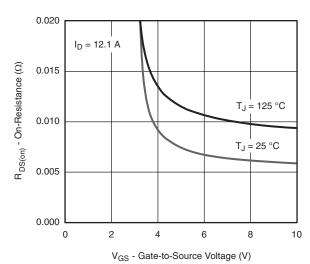
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

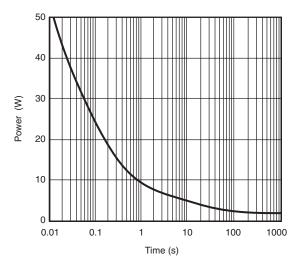


Source-Drain Diode Forward Voltage

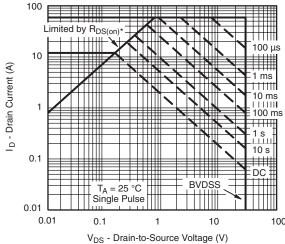




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



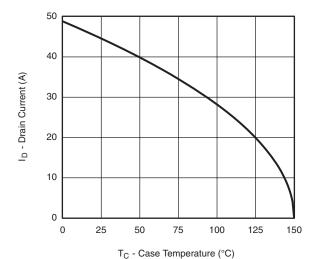
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

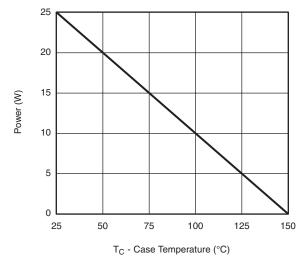


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*



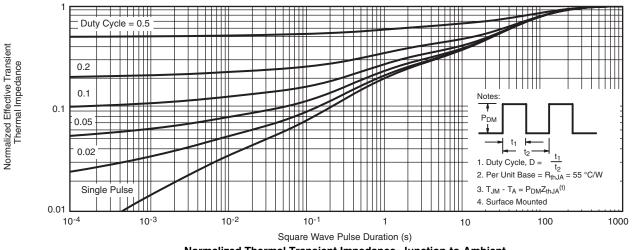
Power Derating, Junction-to-Case

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

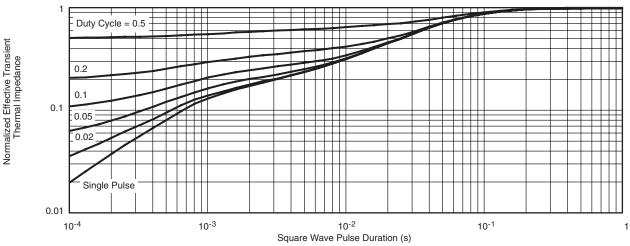
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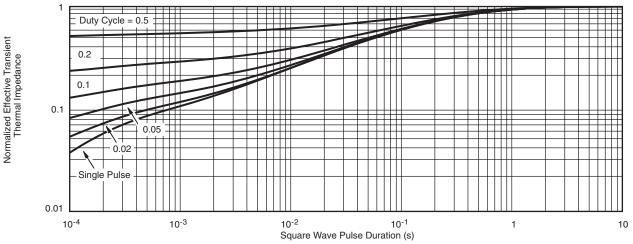
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

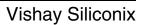


Normalized Thermal Transient Impedance, Junction-to-Case (Drain Top)



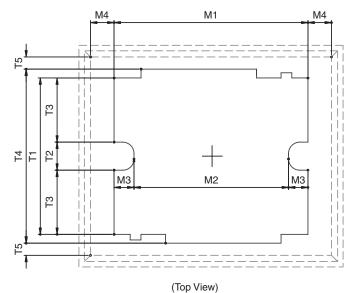
Normalized Thermal Transient Impedance, Junction-to-Source

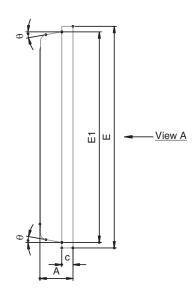
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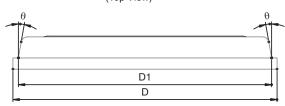


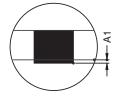


POLARPAK™ OPTION U

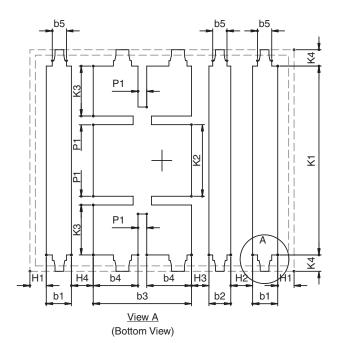


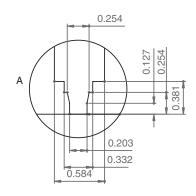






DETAIL Z





Document Number: 68797

Revision: 11-Aug-08

Package Information

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	MILLIMETERS			INCHES			
DIM	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.75	0.80	0.85	0.030	0.031	0.033	
A1	0.00	-	0.05	0.000	-	0.002	
b1	0.48	0.58	0.68	0.019	0.023	0.027	
b2	0.41	0.51	0.61	0.016	0.020	0.024	
b3	2.19	2.29	2.39	0.086	0.090	0.094	
b4	0.89	1.04	1.19	0.035	0.041	0.047	
b5	0.23	0.33	0.43	0.009	0.013	0.017	
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	6.00	6.15	6.30	0.236	0.242	0.248	
D1	5.74	5.89	6.04	0.226	0.232	0.238	
E	5.01	5.16	5.31	0.197	0.203	0.209	
E1	4.75	4.90	5.05	0.187	0.193	0.199	
H1	0.23	-	-	0.009	-	1	
H2	0.45	-	0.56	0.018	-	0.022	
H3	0.31	0.41	0.51	0.012	0.016	0.020	
H4	0.45	-	0.56	0.018	-	0.022	
K1	4.22	4.37	4.52	0.166	0.172	0.178	
K2	1.62	1.67	1.72	0.064	0.066	0.068	
K3	1.16	-	-	0.046	-	1	
K4	0.24	-	-	0.009	-	-	
M1	4.30	4.50	4.70	0.169	0.177	0.185	
M2	3.43	3.58	3.73	0.135	0.141	0.147	
M3	0.22	-	-	0.009	-	-	
M4	0.05	-	-	0.002	-	-	
P1	0.15	0.20	0.25	0.006	0.008	0.010	
T1	3.48	3.64	4.10	0.137	0.143	0.161	
T2	0.56	0.76	0.95	0.022	0.030	0.037	
T3	1.20	-	-	0.047	-	•	
T4	3.90	-	-	0.153	-	-	
T5	0	0.18	0.36	0.000	0.007	0.014	
θ	0°	10°	12°	0°	10°	12°	

ECN: T-08441-Rev. A, 11-Aug-08

DWG: 5966

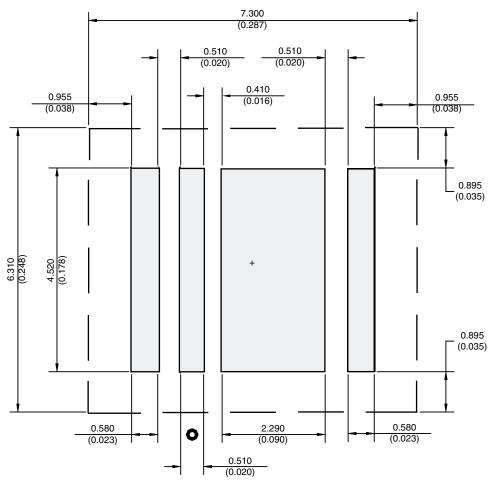
Notes

Millimeters govern over inches.

APPLICATION NOTE



RECOMMENDED MINIMUM PADS FOR PolarPAK® Option L and S



Recommended Minimum for PolarPAK Option L and S Dimensions in mm/(Inches) No External Traces within Broken Lines Dot indicates Gate Pin (Part Marking)

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